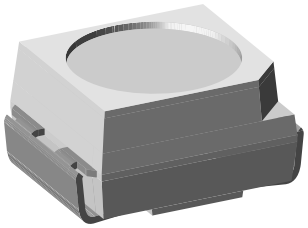
SMD LED in PLCC-2 Package

Description

These devices have been designed to meet the increasing demand for surface mounting technology.

The package of the VLM.310. is the PLCC-2.

It consists of a lead frame which is embedded in a white thermoplast. The reflector inside this package is filled up with clear epoxy.



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Features

- Lead (Pb)-free product-RoHS compliant
- SMD LEDs with exceptional brightness
- Luminous intensity categorized
- Compatible with automatic placement equipment
- EIA and ICE standard package
- Compatible with infrared, vapor phase and wave solder processes according to CECC 00802 and J-STD-020B
- Available in 8 mm tape
- Low profile package
- Non-diffused lens: excellent for coupling to light pipes and backlighting
- Low power consumption
- Luminous intensity ratio in one packaging unit $I_{Vmax}/I_{Vmin} \leq 1.6$
- Preconditioning: acc. to JEDEC Level 2a

Applications

Automotive: Backlighting in dashboards and switches

Telecommunication: Indicator and backlighting in telephone and fax

Indicator and backlight for audio and video equipment

Indicator and backlight in office equipment

Flat backlight for LCDs, switches and symbols

General use

Parts Table

Part	Color, Luminous Intensity	Angle of Half Intensity (±φ)	Technology
VLMH3100-GS08 VLMH3100-GS18	Red, I_V > 2.8 mcd	60°	GaAsP on GaP
VLMH3102-GS08 VLMH3102-GS18	Red, I_V = (7.1 to 18) mcd	60°	GaAsP on GaP
VLMO3100-GS08 VLMO3100-GS18	Soft orange, I_V > 2.8 mcd	60°	GaAsP on GaP
VLMO3101-GS08 VLMO3101-GS18	Soft orange, I_V = (4.5 to 11.2) mcd	60°	GaAsP on GaP
VLMY3100-GS08 VLMY3100-GS18	Yellow, I_V > 2.8 mcd	60°	GaAsP on GaP
VLMY3101-GS08 VLMY3101-GS18	Yellow, I_V = (4.5 to 11.2) mcd	60°	GaAsP on GaP
VLMY3102-GS08 VLMY3102-GS18	Yellow, I_V = (7.1 to 18) mcd	60°	GaAsP on GaP
VLMG3100-GS08 VLMG3100-GS18	Green, I_V > 4.5 mcd	60°	GaP on GaP

Part	Color, Luminous Intensity	Angle of Half Intensity (±φ)	Technology
VLMG3102-GS08 VLMG3102-GS18	Green, I_V = (11.2 to 18) mcd	60°	GaP on GaP
VLMG3105-GS08 VLMG3105-GS18	Green, I_V = (7.1 to 18) mcd	60°	GaP on GaP
VLMP3100-GS08 VLMP3100-GS18	Pure green, I_V > 1.12 mcd	60°	GaP on GaP
VLMP3101-GS08 VLMP3101-GS18	Pure green, I_V = (1.8 to 4.5) mcd	60°	GaP on GaP
VLMP3107-GS08 VLMP3107-GS18	Pure green, I_V = (2.8 to 5.6) mcd	60°	GaP on GaP
VLMP3102-GS08 VLMP3102-GS18	Pure green, I_V = (2.8 to 7.1) mcd	60°	GaP on GaP

Absolute Maximum Ratings

T_{amb} = 25 °C, unless otherwise specified

VLMG310. ,VLMH310. ,VLMO310. ,VLMP310. ,VLMY310.

Parameter	Test condition	Symbol	Value	Unit
Reverse voltage		V_R	6	V
DC forward current	$T_{amb} \leq 60$ °C	I_F	30	mA
Surge forward current	$t_p \leq 10$ µs	I_{FSM}	0.5	A
Power dissipation	$T_{amb} \leq 60$ °C	P_V	100	mW
Junction temperature		T_j	100	°C
Operating temperature range		T_{amb}	- 40 to + 100	°C
Storage temperature range		T_{stg}	- 55 to + 100	°C
Soldering temperature	t ≤ 5 s	T_{sd}	260	°C
Thermal resistance junction/ ambient	mounted on PC board (pad size > 16 mm^2)	R_{thJA}	400	K/W

Optical and Electrical Characteristics

T_{amb} = 25 °C, unless otherwise specified

Red

VLMH310.

Parameter	Test condition	Part	Symbol	Min	Typ.	Max	Unit
Luminous intensity [1]	I_F = 10 mA	VLMH3100	I_V	2.8	10		mcd
		VLMH3102	I_V	7.1		18	mcd
Dominant wavelength	I_F = 10 mA		λ_d	612		625	nm
Peak wavelength	I_F = 10 mA		λ_p		635		nm
Angle of half intensity	I_F = 10 mA		φ		± 60		deg
Forward voltage	I_F = 20 mA		V_F		2	2.8	V
Reverse voltage	I_R = 10 µA		V_R	6	15		V
Junction capacitance	V_R = 0, f = 1 MHz		C_j		15		pF

[1] in one Packing Unit $I_{Vmax}/I_{Vmin} \leq 1.6$

Soft Orange

VLMO310.

Parameter	Test condition	Part	Symbol	Min	Typ.	Max	Unit
Luminous intensity [1]	I_F = 10 mA	VLMO3100	I_V	2.8	8		mcd
		VLMO3101	I_V	4.5		11.2	mcd
Dominant wavelength	I_F = 10 mA		λ_d	598		611	nm
Peak wavelength	I_F = 10 mA		λ_p		605		nm
Angle of half intensity	I_F = 10 mA		φ		± 60		deg
Forward voltage	I_F = 20 mA		V_F		2	2.8	V
Reverse voltage	I_R = 10 µA		V_R	6	15		V
Junction capacitance	V_R = 0, f = 1 MHz		C_j		15		pF

[1] in one Packing Unit $I_{Vmax}/I_{Vmin} \leq 1.6$

Yellow

VLMY310.

Parameter	Test condition	Part	Symbol	Min	Typ.	Max	Unit
Luminous intensity [1]	I_F = 10 mA	VLMY3100	I_V	2.8	10		mcd
		VLMY3101	I_V	4.5		11.2	mcd
		VLMY3102	I_V	7.1		18	mcd
Dominant wavelength	I_F = 10 mA		λ_d	581		594	nm
Peak wavelength	I_F = 10 mA		λ_p		585		nm
Angle of half intensity	I_F = 10 mA		φ		± 60		deg
Forward voltage	I_F = 20 mA		V_F		2.1	2.8	V
Reverse voltage	I_R = 10 µA		V_R	6	15		V
Junction capacitance	V_R = 0, f = 1 MHz		C_j		15		pF

[1] in one Packing Unit $I_{Vmax}/I_{Vmin} \leq 1.6$

Green

VLMG310.

Parameter	Test condition	Part	Symbol	Min	Typ.	Max	Unit
Luminous intensity [1]	I_F = 10 mA	VLMG3100	I_V	4.5	16		mcd
		VLMG3102	I_V	11.2		18	mcd
		VLMG3105	I_V	7.1		18	mcd
Dominant wavelength	I_F = 10 mA		λ_d	562		575	nm
Peak wavelength	I_F = 10 mA		λ_p		565		nm
Angle of half intensity	I_F = 10 mA		φ		± 60		deg
Forward voltage	I_F = 20 mA		V_F		2.2	2.8	V
Reverse voltage	I_R = 10 µA		V_R	6	15		V
Junction capacitance	V_R = 0, f = 1 MHz		C_j		15		pF

[1] in one Packing Unit $I_{Vmax}/I_{Vmin} \leq 1.6$

Pure green

VLMP310.

Parameter	Test condition	Part	Symbol	Min	Typ.	Max	Unit
Luminous intensity [1]	I_F = 10 mA	VLMP3100	I_V	1.12	4		mcd
		VLMP3101	I_V	1.8		4.5	mcd
		VLMP3102	I_V	2.8		7.1	mcd
		VLMP3107	I_V	2.8		5.6	mcd
Dominant wavelength	I_F = 10 mA		λ_d	555		565	nm
Peak wavelength	I_F = 10 mA		λ_p		555		nm
Angle of half intensity	I_F = 10 mA		φ		± 60		deg
Forward voltage	I_F = 20 mA		V_F		2.1	2.8	V
Reverse voltage	I_R = 10 µA		V_R	6	15		V
Junction capacitance	V_R = 0, f = 1 MHz		C_j		15		pF

[1] in one Packing Unit $I_{Vmax}/I_{Vmin} \leq 1.6$

Luminous Intensity Classification

Group	Light Intensity [mcd]		
Standard	Optional	Min	Max
F	-	-	-
	2	1.40	1.80
G	1	1.80	2.24
	2	2.24	2.80
H	1	2.80	3.55
	2	3.55	4.50
I	1	4.50	5.60
	2	5.60	7.10
K	1	7.10	9.00
	2	9.00	11.20
L	1	11.20	14.00
	2	14.00	18.00
M	1	18.00	22.40
	2	22.40	28.00

Note:

Luminous intensity is tested at a current pulse duration of 25 ms and an accuracy of ± 11 %.

The above Type Numbers represent the order groups which include only a few brightness groups. Only one group will be shipped on each reel (there will be no mixing of two groups on each reel). In order to ensure availability, single brightness groups will not be orderable.

In a similar manner for colors where wavelength groups are measured and binned, single wavelength groups will be shipped on any one reel.

In order to ensure availability, single wavelength groups will not be orderable.

Color Classification

Group	Yellow		Green	
	Dom. wavelength [nm]			
	Min.	Max.	Min.	Max.
0				
1	581	584		
2	583	586		
3	585	588		
4	587	590	564	567
5	589	592	566	569
6	591	594	568	571
7			570	573
8			572	575

Group	Softorange		Pure green	
	Dom. wavelength [nm]			
	Min.	Max.	Min.	Max.
0			555	559
1	598	601	558	561
2	600	603	560	563
3	602	605	562	565
4	604	607		
5	606	609		
6	608	611		

Crossing Table

Vishay	Osram	Stanley
VLMH3100	-	-
VLMH3102	-	-
VLMO3100	LOT670J1L2	-
VLMO3101	LOT670J1K2	-
VLMY3100	LYT670J1L2	-
VLMY3101	LYT670J1K2	-
VLMY3102	LYT670K1L2	-
VLMG3100	LGT670K1M2	VYBG1104B
VLMG3102	LGT670L1L2	-
VLMG3105	LGT671K1L2	-
VLMP3100	LPT670F2J2	-
VLMP3101	LPT670G1H2	VYBG1101W
VLMP3102	LPT670H1J2	-
VLMP3107	LPT670H1J1	-

Typical Characteristics (T_{amb} = 25 °C unless otherwise specified)

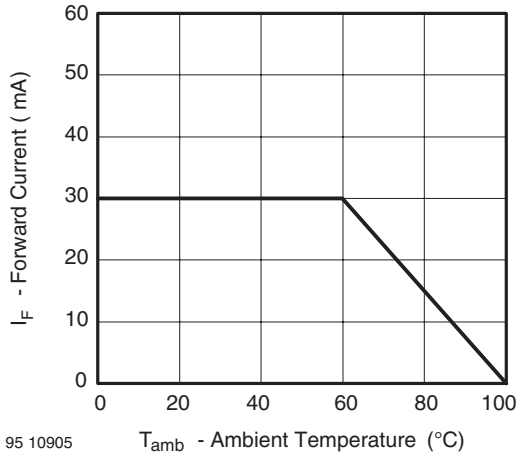


Figure 1. Forward Current vs. Ambient Temperature for InGaN

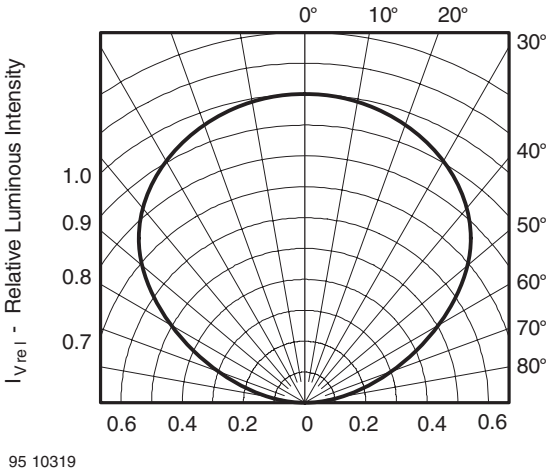


Figure 3. Rel. Luminous Intensity vs. Angular Displacement

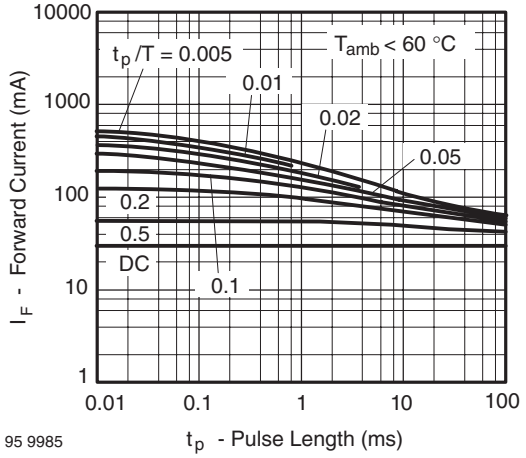


Figure 2. Pulse Forward Current vs. Pulse Duration

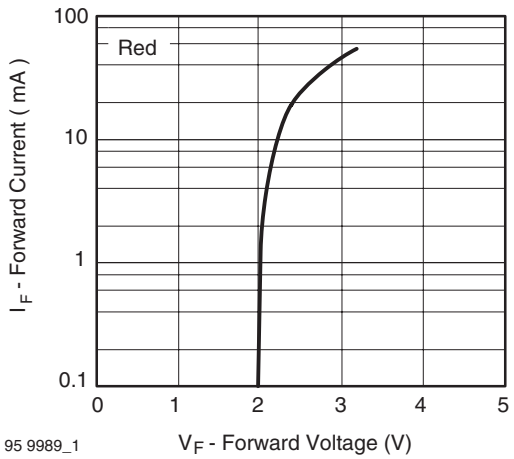


Figure 4. Forward Current vs. Forward Voltage

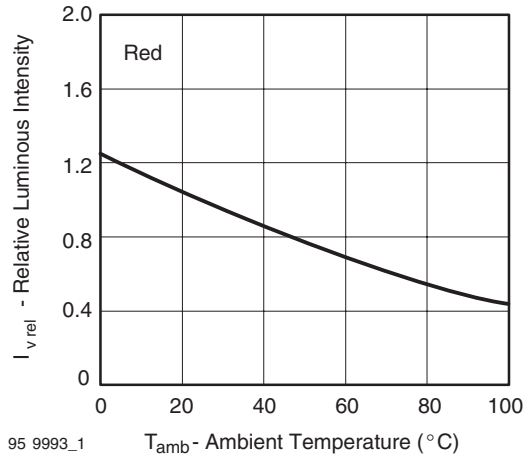


Figure 5. Rel. Luminous Intensity vs. Ambient Temperature

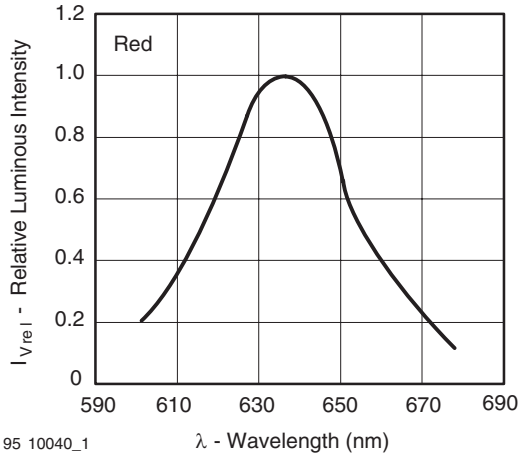


Figure 8. Relative Intensity vs. Wavelength

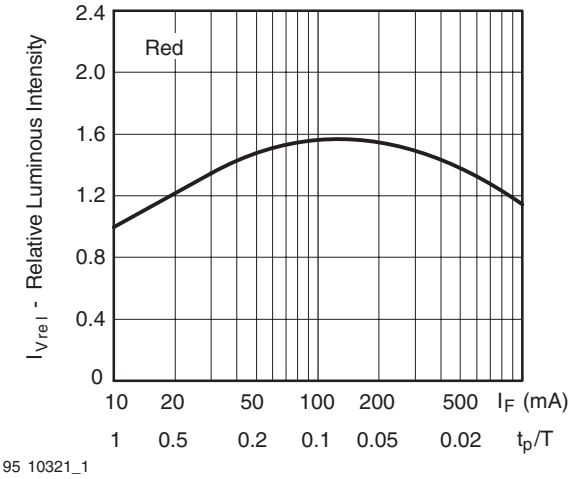


Figure 6. Rel. Lumin. Intensity vs. Forw. Current/Duty Cycle

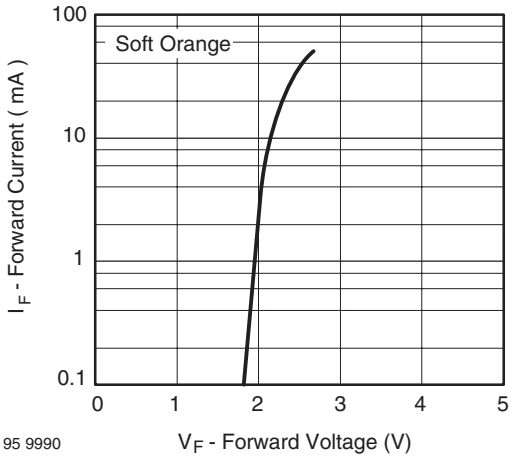


Figure 9. Forward Current vs. Forward Voltage

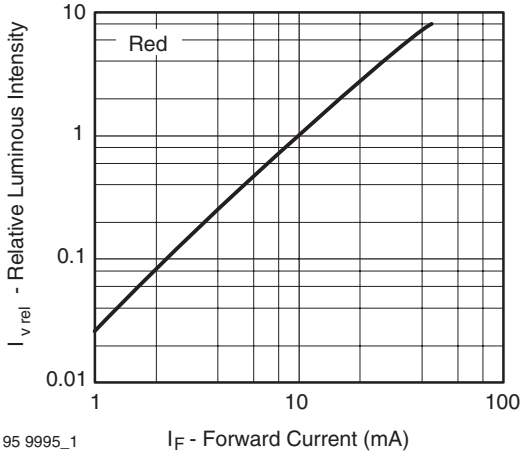


Figure 7. Relative Luminous Intensity vs. Forward Current

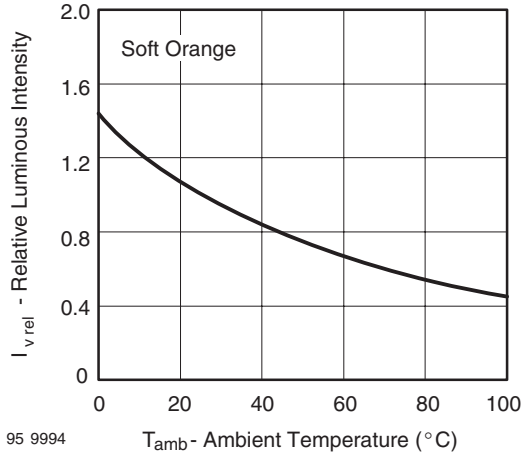


Figure 10. Rel. Luminous Intensity vs. Ambient Temperature

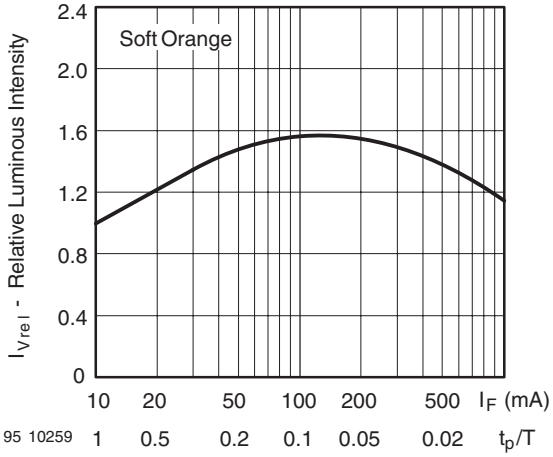


Figure 11. Rel. Lumin. Intensity vs. Forw. Current/Duty Cycle

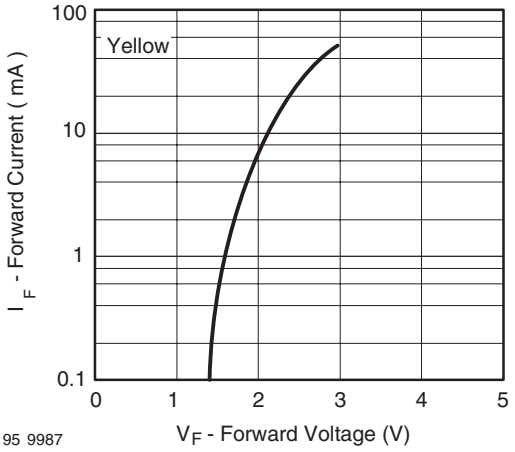


Figure 14. Forward Current vs. Forward Voltage

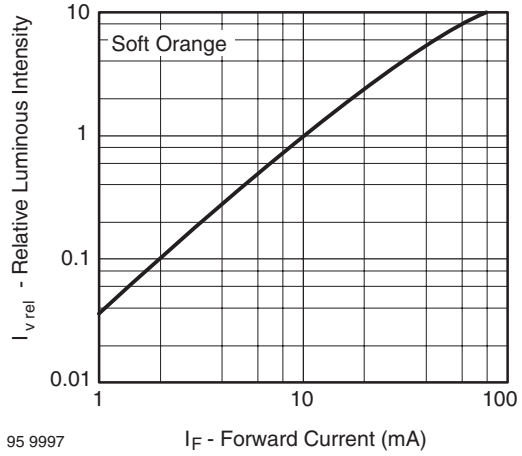


Figure 12. Relative Luminous Intensity vs. Forward Current

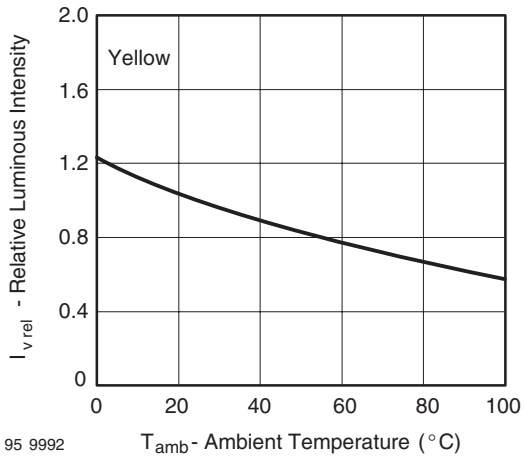


Figure 15. Rel. Luminous Intensity vs. Ambient Temperature

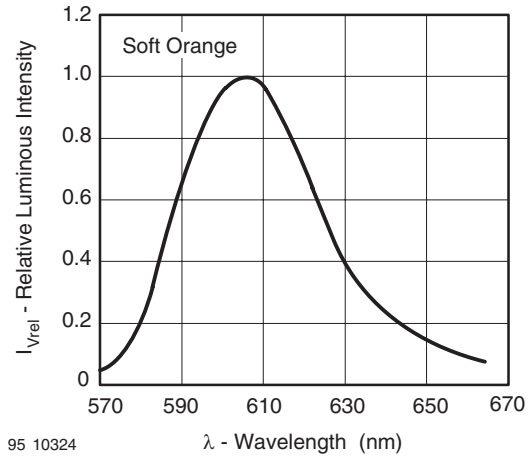


Figure 13. Relative Intensity vs. Wavelength

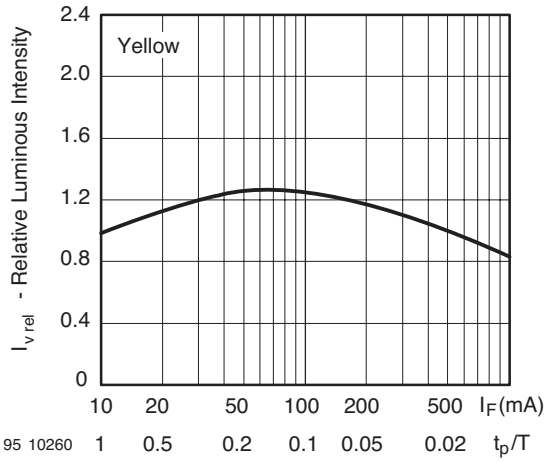


Figure 16. Rel. Lumin. Intensity vs. Forw. Current/Duty Cycle

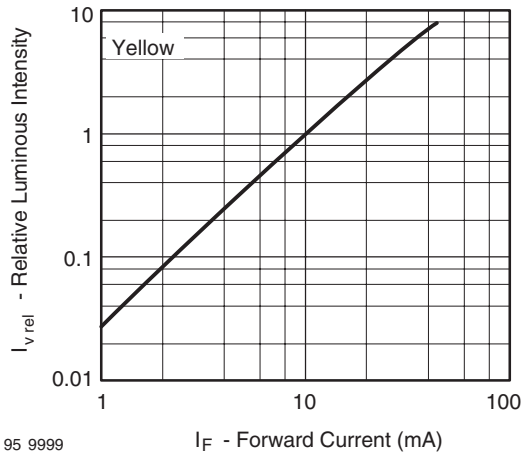


Figure 17. Relative Luminous Intensity vs. Forward Current

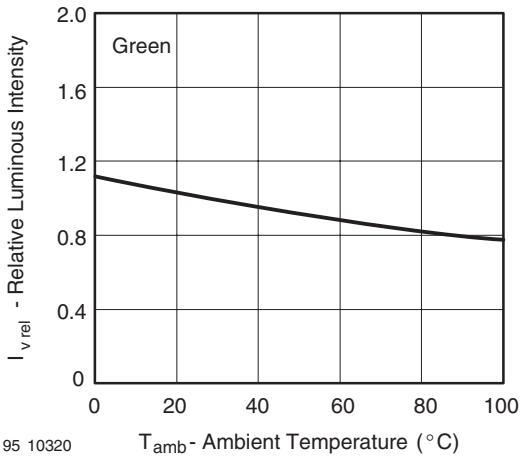


Figure 20. Rel. Luminous Intensity vs. Ambient Temperature

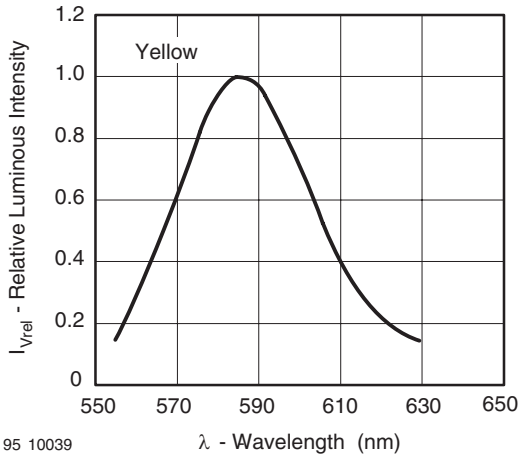


Figure 18. Relative Intensity vs. Wavelength

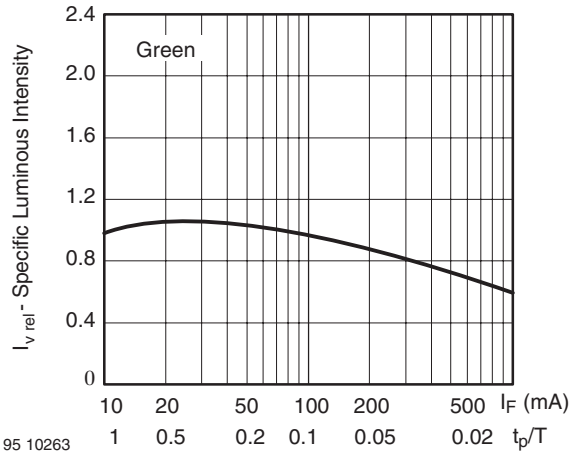


Figure 21. Specific Luminous Intensity vs. Forward Current

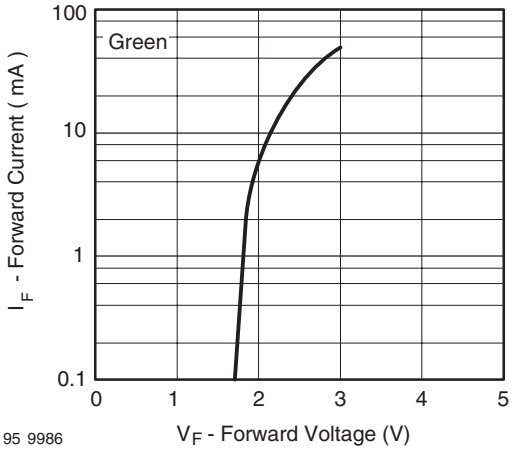


Figure 19. Forward Current vs. Forward Voltage

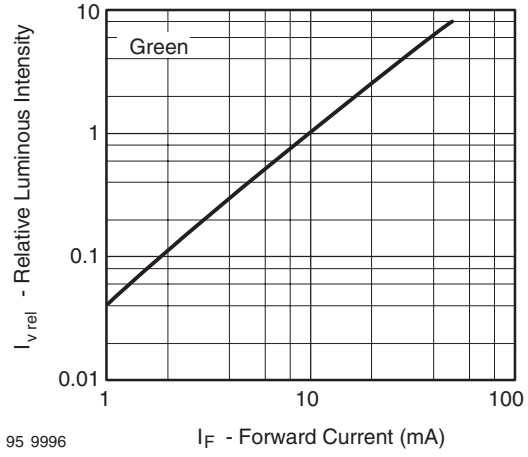


Figure 22. Relative Luminous Intensity vs. Forward Current

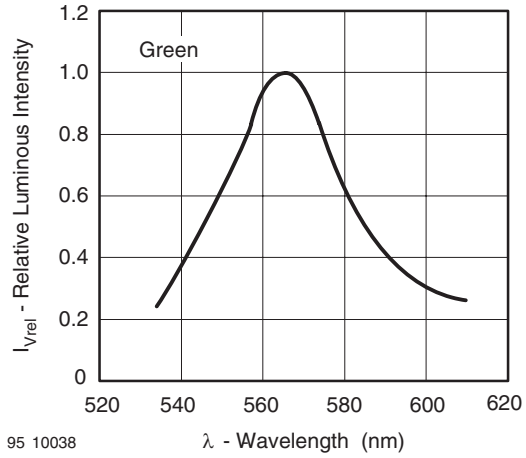


Figure 23. Relative Intensity vs. Wavelength

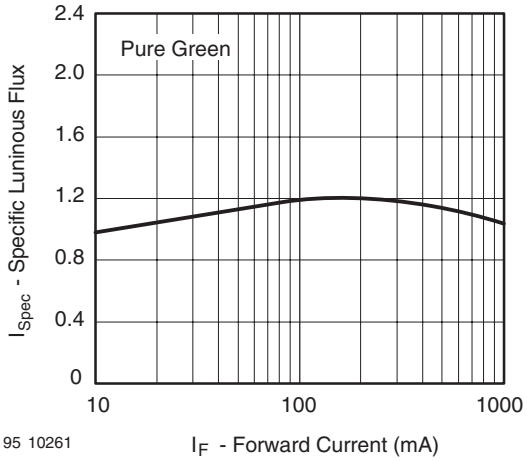


Figure 26. Specific Luminous Intensity vs. Forward Current

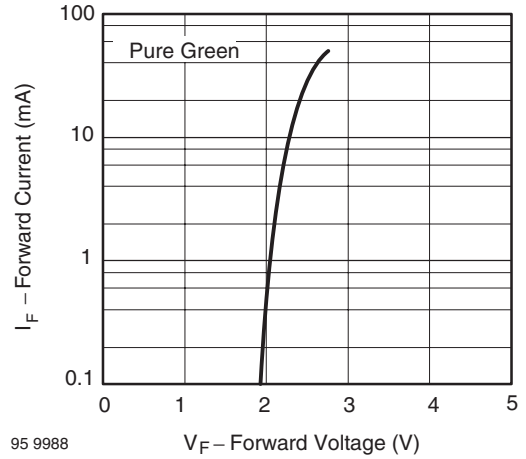


Figure 24. Forward Current vs. Forward Voltage

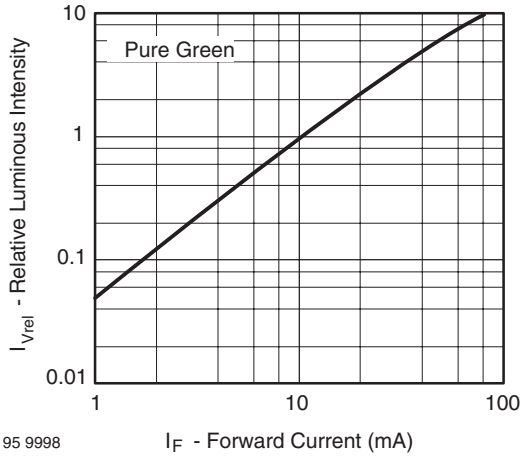


Figure 27. Relative Luminous Intensity vs. Forward Current

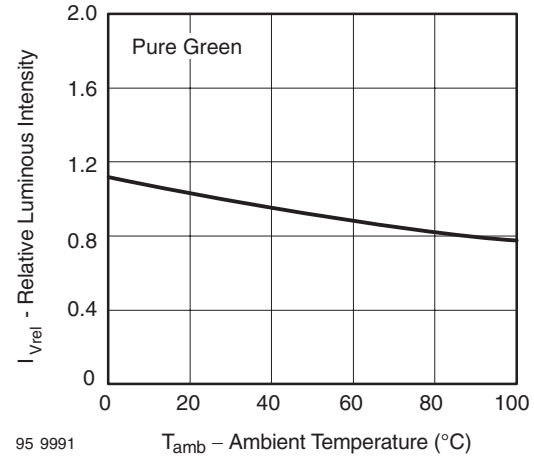


Figure 25. Rel. Luminous Intensity vs. Ambient Temperature

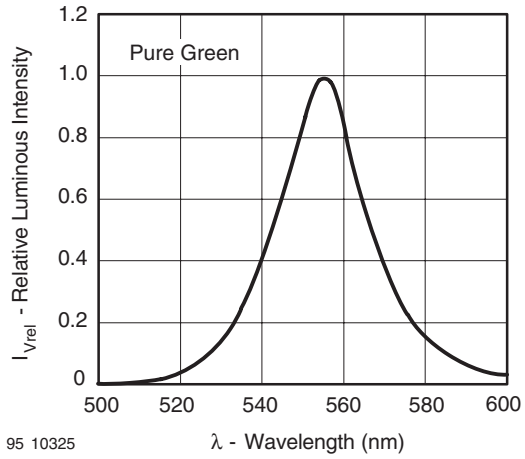
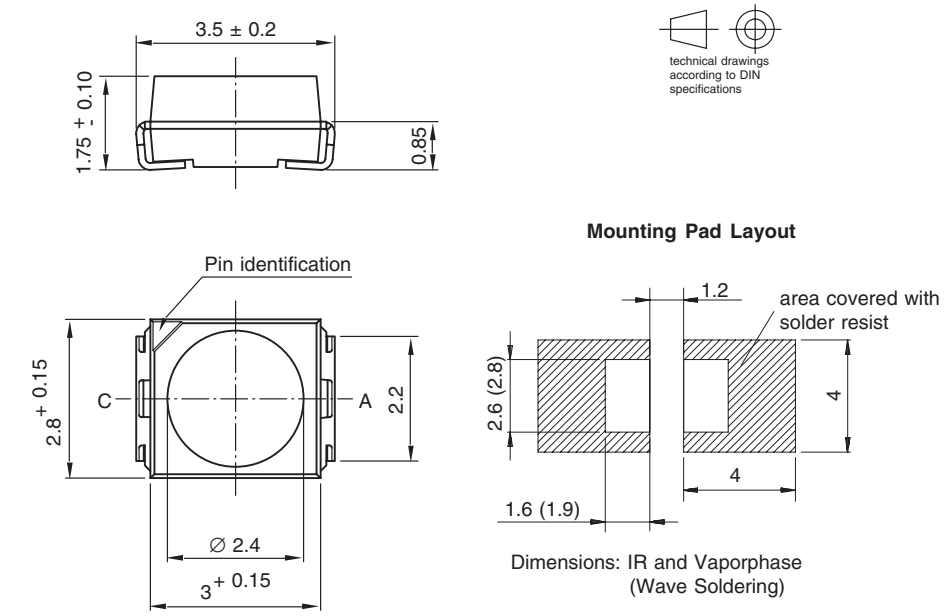


Figure 28. Relative Intensity vs. Wavelength

Package Dimensions in mm

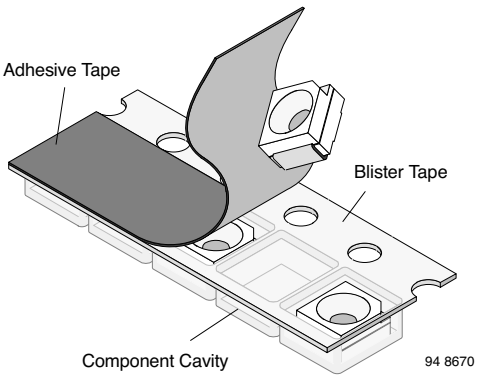


Drawing-No. : 6.541-5025.01-4
95 11314-1 Issue: 7; 05.04.04

Method of Taping / Polarity and Tape and Reel

SMD LED (VLM3 - series)

Vishay's LEDs in SMD packages are available in an antistatic 8 mm blister tape (in accordance with DIN IEC 40 (CO) 564) for automatic component insertation. The blister tape is a plastic strip with impressed component cavaties, covered by a top tape.



Taping of VLM.3..

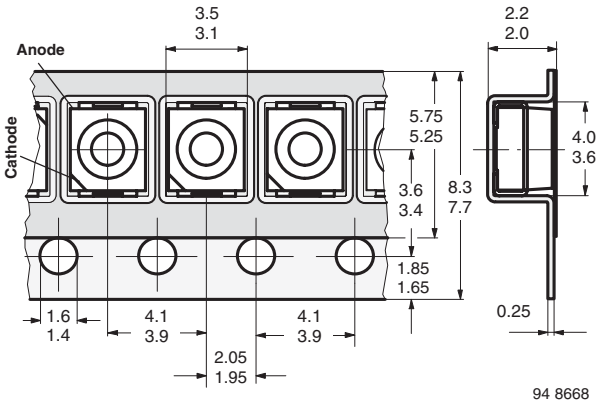


Figure 29. Tape dimensions in mm for PLCC-2

Reel Package dimension in mm for SMD LEDs, tape option GS08 (= 1500 pcs.)

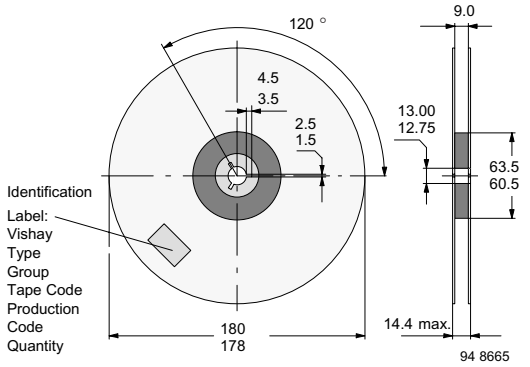


Figure 30. Reel dimensions - GS08

Reel Package dimension in mm for SMD LEDs, tape option GS18 (= 8000 pcs.) prefered

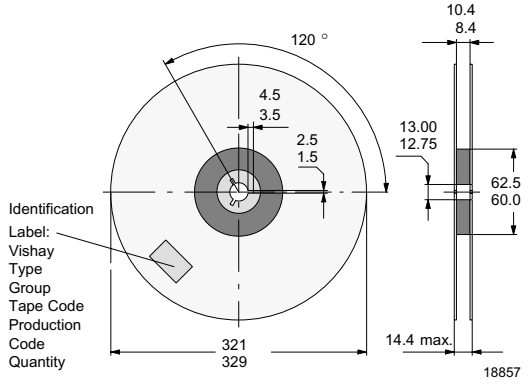


Figure 31. Reel dimensions - GS18

Soldering Profile

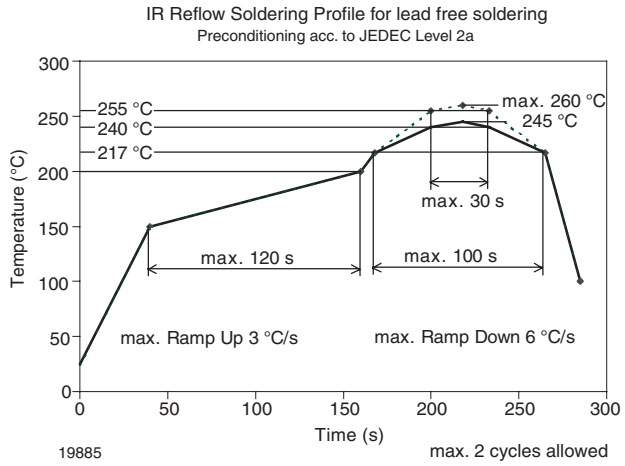


Figure 32. Vishay Leadfree Reflow Soldering Profile
(acc. to J-STD-020B)

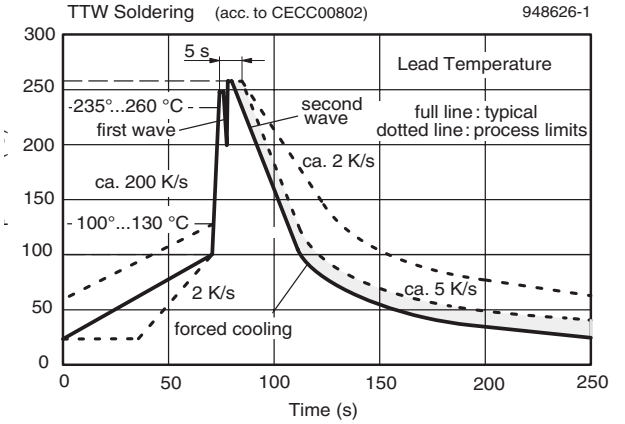
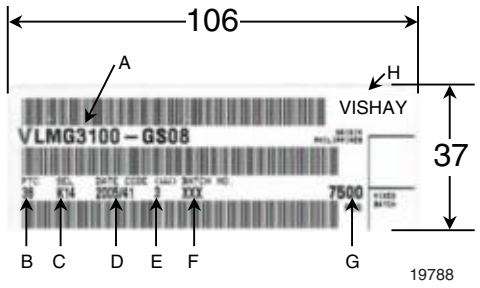


Figure 33. Double wave soldering of opto devices (all packages)

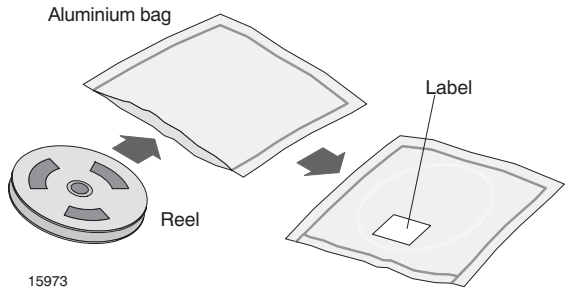
Barcode-Product-Label



A) Type of component
B) Manufacturing plant
C) SEL - Selection Code (Bin):
e.g.: K1 = Code for Luminous Intensity Group
4 = Code for Color Group
D) Date Code year/week
E) Day Code (e.g. 2: Tuesday)
F) Batch No.
G) Total quantity
H) Company Code

Dry Packing

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



Final Packing

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

Recommended Method of Storage

Dry box storage is recommended as soon as the aluminium bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 672 hours under these conditions moisture content will be too high for reflow soldering.

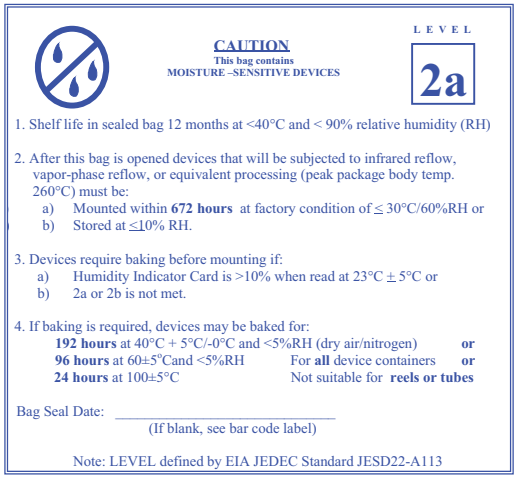
In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 hours at 40 °C + 5 °C/ - 0 °C and < 5 % RH (dry air/ nitrogen) or

96 hours at 60 °C + 5 °C and < 5 % RH for all device containers or

24 hours at 100 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC Standard JESD22-A112 Level 2a label is included on all dry bags.



Example of JESD22-A112 Level 2a label

ESD Precaution

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the Antistatic Shielding Bag. Electro-Static Sensitive Devices warning labels are on the packaging.

Vishay Semiconductors Standard Bar-Code Labels

The Vishay Semiconductors standard bar-code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.

Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany

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